	SN64BCT374
OCTAL EDGE-TRIGGERED	D-TYPE FLIP-FLOP
WITH	3-STATE OUTPUTS

SCBS066A – JUNE 1990 – REVISED NOVEMBER 1993

	SCBS066A – JUNE 1990 – REVISE
 State-of-the-Art BiCMOS Design	DW OR N PACKAGE
Significantly Reduces I _{CCZ}	(TOP VIEW)
 ESD Protection Exceeds 2000 V Per	OE 1 20 V _{CC}
MIL-STD-883C, Method 3015; Exceeds 200 V	1Q 2 19 8Q
Using Machine Model (C = 200 pF, R = 0)	1D 3 18 8D
 High-Impedance State During Power Up and	2D 4 17 7D
Power Down	2Q 5 16 7Q
 3-State True Outputs Drive Bus Lines or	3Q [6 15] 6Q
Buffer-Memory Address Registers	3D [7 14] 6D
Full Parallel Access for Loading	4D 🛛 8 13 🗍 5D
 Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic 300-mil DIPs (N) 	4Q 9 12 5Q GND 10 11 CLK

description

This 8-bit flip-flop features 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. It is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight flip-flops of the SN64BCT374 are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels that were set up at the data (D) inputs.

A buffered output-enable (\overline{OE}) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

The output-enable (\overline{OE}) does not affect the internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The outputs are in a high-impedance state during power up and power down when the supply voltage is less than approximately 3 V.

The SN64BCT374 is characterized for operation from –40°C to 85°C and 0°C to 70°C.

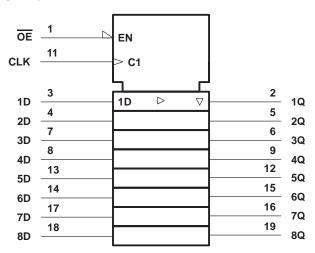
FUNCTION TABLE (each flip-flop)							
	INPUTS	OUTPUT					
OE	CLK	D	Q				
L	\uparrow	Н	Н				
L	\uparrow	L	L				
L	L	Х	Q ₀				
Н	Х	Х	Z				



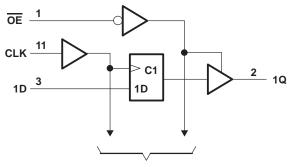
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logic symbol[†]



logic diagram (positive logic)



To Seven Other Channels

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, VI (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the disabled or power-off state, VO	–0.5 V to 5.5 V
Voltage range applied to any output in the high state, Vo	
Input clamp current, I _{IK} (V _I < 0)	
Current into any output in the low state, I _O	128 mA
Operating free-air temperature range	–40°C to 85°C
Storage temperature range	

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions (see Note 2)

		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
lik	Input clamp current			-18	mA
IOH	High-level output current			-15	mA
IOL	Low-level output current			64	mA
$\Delta t / \Delta V_{CC}$	Power-up ramp rate	2			μs/V
TA	Operating free-air temperature	-40		85	°C

NOTE 2: Unused or floating inputs must be held high or low.



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PARAMETER	TEST CONDITIONS				TYP†	MAX	UNIT
VIK	V _{CC} = 4.5 V,	lj = -18 mA				-1.2	V
		$I_{OH} = -3 \text{ mA}$		2.4	3.3		
VOH	$V_{CC} = 4.5 V$	I _{OH} = – 15 mA		2	3.1		V
V _{OL}	$V_{CC} = 4.5 V,$	I _{OL} = 64 mA			0.42	0.55	V
lj	$V_{CC} = 5.5 V,$	V _I = 5.5 V				0.4	mA
IIН	V _{CC} = 5.5 V,	Vj = 2.7 V				20	μΑ
١ _{IL}	V _{CC} = 5.5 V,	V _I = 0.5 V				-0.6	mA
los‡	V _{CC} = 5.5 V,	$V_{O} = 0$		-100		-225	mA
	$V_{CC} = 0$ to 2.3 V (power up)	V _O = 2.7 V or 0.5 V,	<u>OE</u> = 0.8 V			±50	
I _{OZ}	V_{CC} = 1.8 V to 0 (power down)		0E = 0.8 V			±50	μA
IOZH	V _{CC} = 5.5 V,	V _O = 2.7 V				50	μΑ
IOZL	V _{CC} = 5.5 V,	$V_{O} = 0.5 V$				-50	μΑ
ICCL	V _{CC} = 5.5 V,	Outputs open			37	60	mA
IССН	$V_{CC} = 5.5 V,$	Outputs open			2	5	mA
Iccz	$V_{CC} = 5.5 V,$	Outputs open			5	8	mA
Ci	$V_{CC} = 5 V,$	$V_I = 2.5 \text{ V or } 0.5 \text{ V}$			6		pF
Co	$V_{CC} = 5 V,$	V _O = 2.5 V or 0.5 V			10		pF

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[‡]Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

timing requirements over recommended range of supply voltage (unless otherwise noted)

		V _{CC} = 5 V, T _A = 25°C		V _{CC} = 4.5 V to 5.5 V				
				T _A = −40°C to 85°C		T _A = 0°C to 70°C		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
fclock	Clock frequency		70		70		70	MHz
tw	Pulse duration, CLK high	7		7		7		ns
t _{su}	Setup time, data before CLK1	6.5		6.5		6.5		ns
t _h	Hold time, data after CLK^\uparrow	0		0		0		ns

switching characteristics over recommended range of supply voltage, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Note 3)

PARAMETER	FROM	TO	V(T/	C = 5 V ∖ = 25°C	,	T _A = - to 8		T _A = to 70		UNIT
	(INPUT) (OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX		
f _{max}			70			70		70		MHz
^t PLH	CLK	0	2	7.2	9.1	2	11.6	2	10.6	20
^t PHL		Q	2	7.1	8.8	2	10.6	2	10	ns
^t PZH	OE	0	1	8.3	10.1	1	12.7	1	12.3	
^t PZL		Q	1	8.6	10.6	1	13	1	12.7	ns
^t PHZ	OE	Q	1	4.7	6.3	1	7.1	1	6.8	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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